

## N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)		
40	0.012 at V <sub>GS</sub> = 10 V	12	15 nC		
40	0.012 at V <sub>GS</sub> = 4.5 V	9	10110		

8 D

6

5

7 D

D

D

SO-8

Top View

S 1

S 2

S 3

G

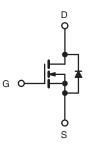
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#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS directive 2002/95/EC

#### **APPLICATIONS**

- Synchronous Rectification
- POL, IBC
  - Secondary Side



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		12		
Continuous Drain Current (T $= 150$ °C)	T <sub>C</sub> = 70 °C		8		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	- I <sub>D</sub> -	12.4 <sup>a, b</sup>	Α	
	T <sub>A</sub> = 70 °C		8.8 <sup>a, b</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	50		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	15		
Avalanche Energy		E <sub>AS</sub>	11	mJ	
Orational Designation	T <sub>C</sub> = 25 °C		5	Α	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.1 <sup>a, b</sup>	A	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	– P <sub>D</sub>	6		
	T <sub>C</sub> = 70 °C		3.8	w	
	T <sub>A</sub> = 25 °C		2.5 <sup>a, b</sup>	vv	
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	37	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	17	21	0/11		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85  $^{\circ}\text{C/W}.$ 

d. Based on T<sub>C</sub> = 25 °C.



<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
t Conditions	Min.	Тур.	Max.	Unit			
		•		1			
0 V, I <sub>D</sub> = 250 μA	40			V			
<sub>D</sub> = 250 μA		40		mV/°C			
i <sub>D</sub> = 230 μA		- 6		1110/ C			
/ <sub>GS</sub> , I <sub>D</sub> = 250 μA	1		3	V			
0 V, V <sub>GS</sub> = ± 20 V			± 100	nA			
40 V, $V_{GS} = 0 V$ $V_{GS} = 0 V, T_J = 55 °C$			1 5	μA			
$V_{GS} = 0 V, 1 = 35 C$ 5 V, $V_{GS} = 10 V$	50		5	^			
$10 \text{ V}, \text{ I}_{\text{D}} = 12.4 \text{ A}$	50	0.010		A			
		0.010		Ω			
$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10.8 \text{ A}$ $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 12.4 \text{ A}$		0.012					
$15 \text{ V}, \text{ I}_{\text{D}} = 12.4 \text{ A}$		56		S			
	T.	T	г	1			
		2000					
$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, f = 1 MHz		260		pF			
		150					
V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.4 A		33	50	nC			
		15	23				
$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 12.4 A		6.7					
		5.1					
f = 1 MHz		1.4	2.1	Ω			
		25	40				
= 20 V, $R_L$ = 2 $\Omega$		12	20				
$_{\sf GEN}$ = 4.5 V, $\sf R_g$ = 1 $\Omega$		25	40				
		10	15				
		10	15	ns			
= 20 V, R <sub>L</sub> = 2 Ω		15	25	-			
$G_{\text{GEN}}$ = 10 V, R <sub>g</sub> = 1 $\Omega$		30	45				
		10	15				
	•	•					
Г <sub>С</sub> = 25 °С			30				
			50	A			
0 A, V <sub>GS</sub> = 0 V		0.8	1.2	V			
		30	60	ns			
I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		26	52	nC			
		17.5					
4				ns			
			= 100 A/µs, T <sub>1</sub> = 25 °C	= 100 A/µs, T <sub>J</sub> = 25 °C			

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

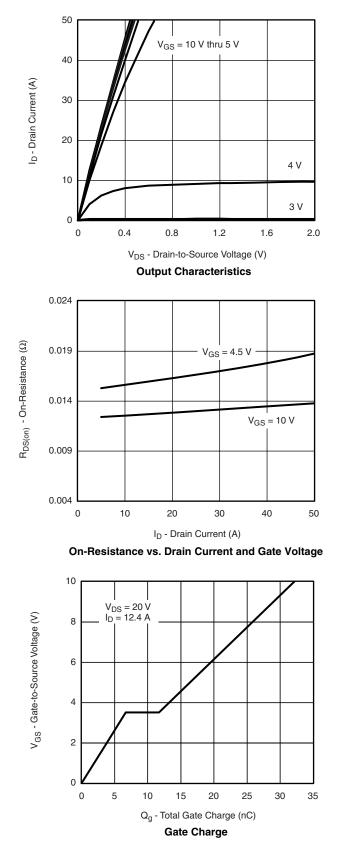
b. Guaranteed by design, not subject to production testing.

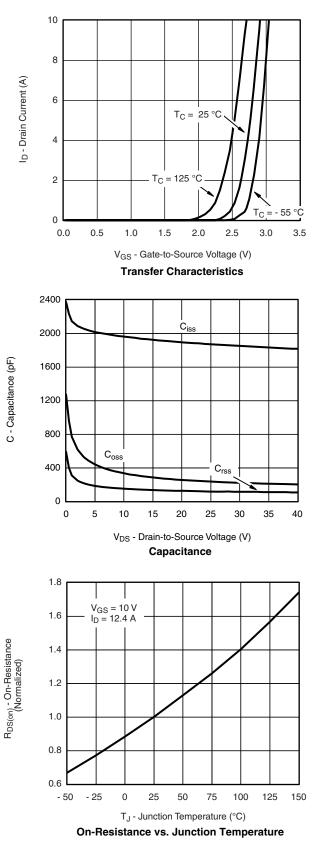
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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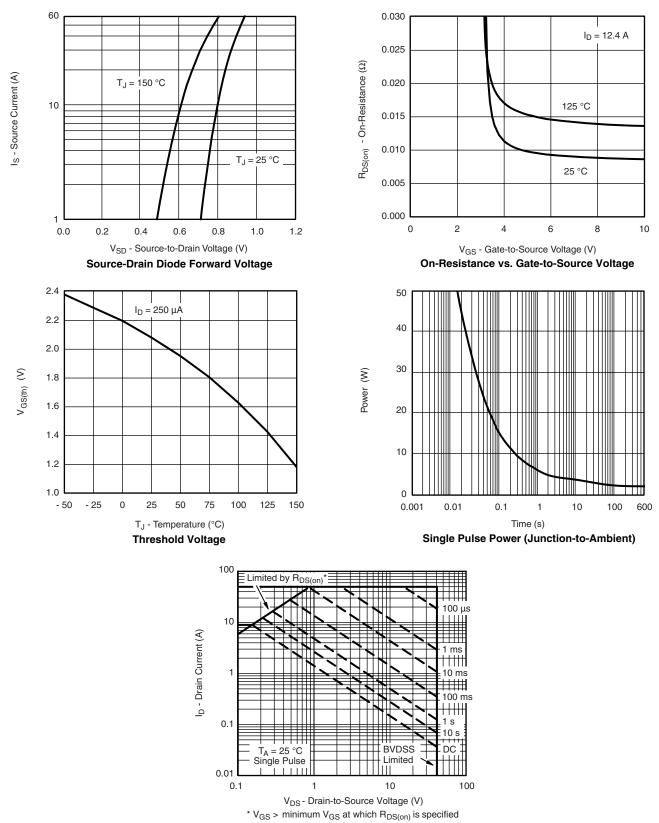
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





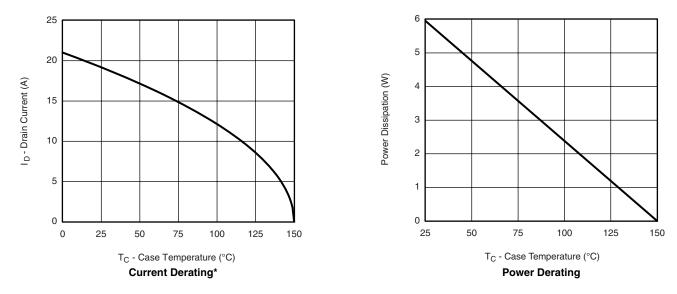


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



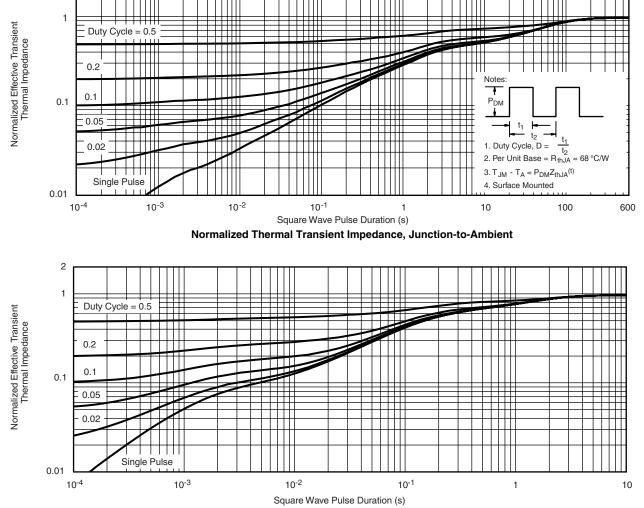


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot

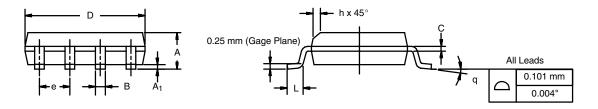
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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012

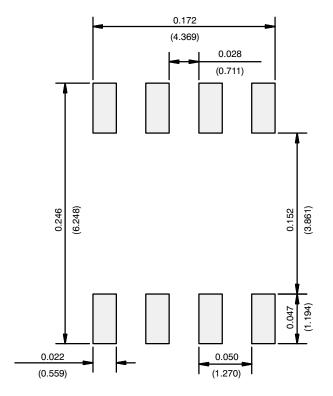




	MILLIM	ETERS	INCHES		
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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